

Product Change Notification

Change Notification #: 115331-00

Change Title: Intel® Compute Module HNS2600KPFR,

HNS2600TPFR and HNS2600TP24R PCN115331-00, Product Material, Replacement of BMC DDR3 chip

Date of Publication: March 13, 2017

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

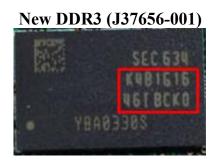
Date Customer Must be Ready to Receive Post-Conversion Material: * April 03, 2017

Description of Change to the Customer:

Intel is implementing the following change to Intel® Compute Module HNS2600KPFR, HNS2600TPFR and HNS2600TP24R:

Intel is replacing the current BMC DDR3 memory chip K4B1G1646G-BCH9 (G38649-001) (end of life) with new K4B1G1646I-BCK0 (J37656-001). Intel reports validation completed with passing results. The replacement component is identical in form, fit and function.

Current DDR3 (G38649-001)



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customers perform a standard level of evaluation.

Please contact your local Intel Sales Office or Distributor if you require more information.

^{*} Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change	Pre Change	Post Change	Post Change
			TA	PBA	TA	PBA
Intel® Compute Module HNS2600KPFR	HNS2600KPFR	943788	H94937-003	G93685-371	H94937-004	G93685-372
Intel® Compute Module HNS2600TPFR	HNS2600TPFR	943949	H94939-004	H14263-271	H94939-005	H14263-272
Intel® Compute Module HNS2600TP24R	HNS2600TP24R	943951	H94945-003	H26989-271	H94945-004	H26989-272

PCN Revision History:

Date of Revision: Revision Number: Reason:

March 13, 2017 00 Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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